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Present Claims

1.   (Currently Amended) A handler for applying a vacuum holding force to an object, the handler comprising:

      a body for applying a vacuum holding force having a plurality of levels of openings including a holding surface level and a suction surface level, wherein the openings at the suction surface level are larger than the openings at the holding surface level, and further wherein the openings at the suction surface level are in fluid communication with at least a portion of the openings at the holding surface level; and

      a vacuum source attached to said body at the suction surface level.

2.   (Previously Presented)   The handler as in claim 1, wherein the openings at the holding surface level create a periodic pattern which is characterized by a frequency which is greater than the frequency of the periodic pattern of openings at the suction surface level.

3.   (Canceled)

4.   (Original)   The handler as in claim 2, further comprising at least one intermediate level between the holding surface level and the suction surface level, wherein the openings of the intermediate level are larger than the openings at the holding surface level and smaller that the openings at the suction surface level.

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5. (Original) The handler as in claim 4, wherein the frequency of the openings at the intermediate level is greater than the frequency of the openings at the suction surface level.

6. (Original) The handler as in claim 5, wherein at least a portion of the openings at the suction surface level that are in fluid communication with at least a portion of the openings at the intermediate level are in direct fluid communication by alignment of the openings, and at least a portion of the openings at the intermediate level that are in fluid communication with at least a portion of the openings at the holding surface level are in direct fluid communication by alignment of the openings,

further comprising interconnecting openings for interconnecting openings at the intermediate level and at the holding surface level that are not in direct fluid communication by alignment of the openings.

7. (Original) The handler as in claim 1, further comprising at least one micro-mechanical valve in at least one of the openings.

8. (Currently Amended) The handler as in claim 1 wherein said body is formed of a material selected from the group consisting of metals, alloys, semiconductor materials, and ceramics.

9. (Currently Amended) The handler as in claim 1 wherein said body is formed of a semiconductor material selected from the group consisting of silicon, III-V type

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semiconductors, II-IV type semiconductors, II-VI type semiconductors, IV-VI type

semiconductors, Ge, C, Si-oxide, and Si-nitride.

10.   (Canceled)

11.   (Canceled)

12.   (Canceled)

13.   (Canceled)

14.   (Canceled)

15.   (Canceled)

16.   (Currently Amended) A handler for applying a vacuum holding force to an object

comprises:

a handler body and a vacuum source attached to said handler body, said handler

body for applying a vacuum holding force having a thickness, a holding surface having a

plurality of holes for imparting vacuum force to an object, and a vacuum surface having

at least one hole for a vacuum source, the holding surface holes having diameters suitable

for holding fragile objects utilizing a vacuum holding force, wherein vacuum paths are

formed from the plurality of holding surface holes to the at least one vacuum surface

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hole, the vacuum paths configured, positioned and dimensioned to reduce resistance of

gas flowing through the vacuum paths.

17.   (Original)   The handler as in claim 16, wherein the ratio of the handler body

thickness to holding surface hole diameter is about 10^7 to about 10^2.

18.   (Original)   The handler as in claim 16, wherein the ratio of the handler body

thickness to holding surface hole diameter is about 10^6 to about 10^3.

19.   (Original)   The handler as in claim 16, wherein the ratio of the handler body

thickness to holding surface hole diameter is about 10^5 to about 10^4.

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<u>In the Title of the Invention</u>

In the Title, please delete "DEVICE FOR HANDLING FRAGILE OBJECTS"

and insert therefore --VACUUM HOLDING DEVICE FOR HANDLING FRAGILE

OBJECTS--.